<u> </u>		
04-29-1999		
101023253 1. Name of conveying party(ies): Kohei TATSUMI Kenji SHIMOKAWA Eiji HASHINO Additional name(s) of conveying party(ies)	Patents and Trademarks:	Please record the attached original documents or copy thereof.
1. Name of conveying party(ies): Kohei TATSUMI	•	2. Name and address of receiving party(ies):
Kenji SHIMOKAWA		Name: NIPPON STEEL CORPORATION
Eiji HASHINO		Internal Address:
Additional name(s) of conveying party(iss)	attached? 🗔 Yes 🙆 No	
3. Nature of conveyance:		
· DK Assignment	Merger	Street Address: 6-3, Otemachi 2-chome,
Security Agreement	Change of Name	Chiyoda-ku, Tokyo, Japan
Other		City:State:ZIP:
Execution Date: March 8, 1	.999	Additional name(s) & address(es) attached? 🗔 Yes 🛛 🛂 No
4. Application number(s) or patent r If this document is being filed toget A. Patent Application No.(s) 09/254,118		e execution date of the application is:
5. Name and address of party to wh concerning document should be r Name:	mailed:	Hed? Yes No   6. Total number of applications and patents involved: 1
Internal Address:		7. Total fee (37 CFR 3.41): \$ 40.00
		Enclosed
		Authorized to be charged to deposit account
Street Address: Kenyon &		
One Broadway	1949 - Carlos Carlos (1949) 	8. Deposit account number: 11-0600
New York	N.Y. 11230	(Attach duplicate copy of this page if paying by deposit accou
City:Sta	te:ZIP: DO NOT USE 1	
9. Statement and signature. To the best of my knowledge and of the original document. Edward W. Greason	belief, the foregoing inform	ation is true and correct and any attached copy is a true copy
Name of Person Signing		Signature Date Total number of pages comprising cover sheet 1
OMB No. 0651-0011 (exp. 4/94)		
29/1999 DNGUYEN 00000475 110600 092	54118 Do not detach	this portion
FC:581 (40.00 CH)		information to-
Mail documents to be record		
Mail documents to be record	Commissioner of F Box Assignments Washington, D.C. 2	
	Box Assignments Washington, D.C. 2	20231
blic burden reporting f rent to be recorded,	Box Assignments Washington, D.C. 2 for this sample cover she including time for review	<b>20231</b> et is estimated to average about 30 minutes per ring the document and gathering the data needed,
ublic burden reporting f ent to be recorded, ring and review	Box Assignments Washington, D.C. 2 for this sample cover she including time for review ving the sample cover she	et is estimated to average about 30 minutes per ring the document and gathering the data needed, et. Send comments regarding this burden estimate
ublic burden reporting f ent to be recorded, ting and review and Tra	Box Assignments Washington, D.C. 2 for this sample cover she including time for review ving the sample cover she idemark Office, Office of	<b>20231</b> et is estimated to average about 30 minutes per ring the document and gathering the data needed,

PATENT REEL: 9907 FRAME: 0818

## MARK C

## U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

(Insert ASSIGNEE's Name(s) Address(es))

NIPPON STEEL CORPORATION

6-3, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan

(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

METHOD OF PARTIALLY PLATING SUBSTRATE FOR ELECTRONIC DEVICES

(Title of Invention)

relating to International Patent Application PCT/JP 97 02988 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(Insert date of execution	(a) executed on;	Kenyon & Kenyon New York, U.S.A.
of application,	(b) filed on,	) is hereby authorized to insert in (b) the specified
if not concurrent)	Serial No;	data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)	1) <i>[</i>	theil abrum	Kohei Tatsumi	March 8, 1999
	I	(SIGNATURE)	(TYPE NAME)	(DATE)
	2 <u></u>	ENJU Shimukuwa (SIGNATURE)	Kenji Shimokawa (TYPE NAME)	March 8, 1999 (DATE)
	31	yr Hashino (SIGNATURE)	Eiji Hashino (TYPE NAME)	March 8, 1999 (DATE)
	4}	(SIGNATURE)	(TYPE NAME)	(DATE)
	5)	(SIGNATURE)	(TYPE NAME)	(DATE)
	6)	(SIGNATURE)	(TYPE NAME)	(DATE)
	7)	(SIGNATURE)	(TYPE NAME)	(DATE)
	8)	(SIGNATURE)	(TYPE NAME)	(DATE)

## PATENT REEL: 9907 FRAME: 0819

**RECORDED: 04/14/1999**